

BLF189XRA; BLF189XRAS

Power LDMOS transistor

AMPLEON

Rev. 1 — 6 November 2017

Product data sheet

1. Product profile

1.1 General description

A 1700 W extremely rugged LDMOS power transistor for broadcast and industrial applications in the HF to 500 MHz band.

Table 1. Application information

Test signal	f	V _{DS}	P _L	G _p	η _D
	(MHz)	(V)	(W)	(dB)	(%)
pulsed RF	108	50	1700	26.2	74

1.2 Features and benefits

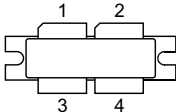
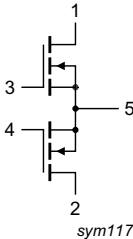
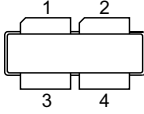
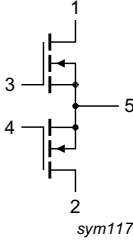
- Easy power control
- Integrated dual sided ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (HF to 500 MHz)
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

- Industrial, scientific and medical applications
- Broadcast transmitter applications

2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
BLF189XRA (SOT539A)			
1	drain1		
2	drain2		
3	gate1		
4	gate2		
5	source [1]		
BLF189XRAS (SOT539B)			
1	drain1		
2	drain2		
3	gate1		
4	gate2		
5	source [1]		

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BLF189XRA	-	flanged balanced ceramic package; 2 mounting holes; 4 leads	SOT539A
BLF189XRAS	-	earless flanged balanced ceramic package; 4 leads	SOT539B

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	135	V
V_{GS}	gate-source voltage		-6	+11	V
T_{stg}	storage temperature		-65	+150	°C
T_j	junction temperature ^[1]		-	225	°C

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

5. Thermal characteristics

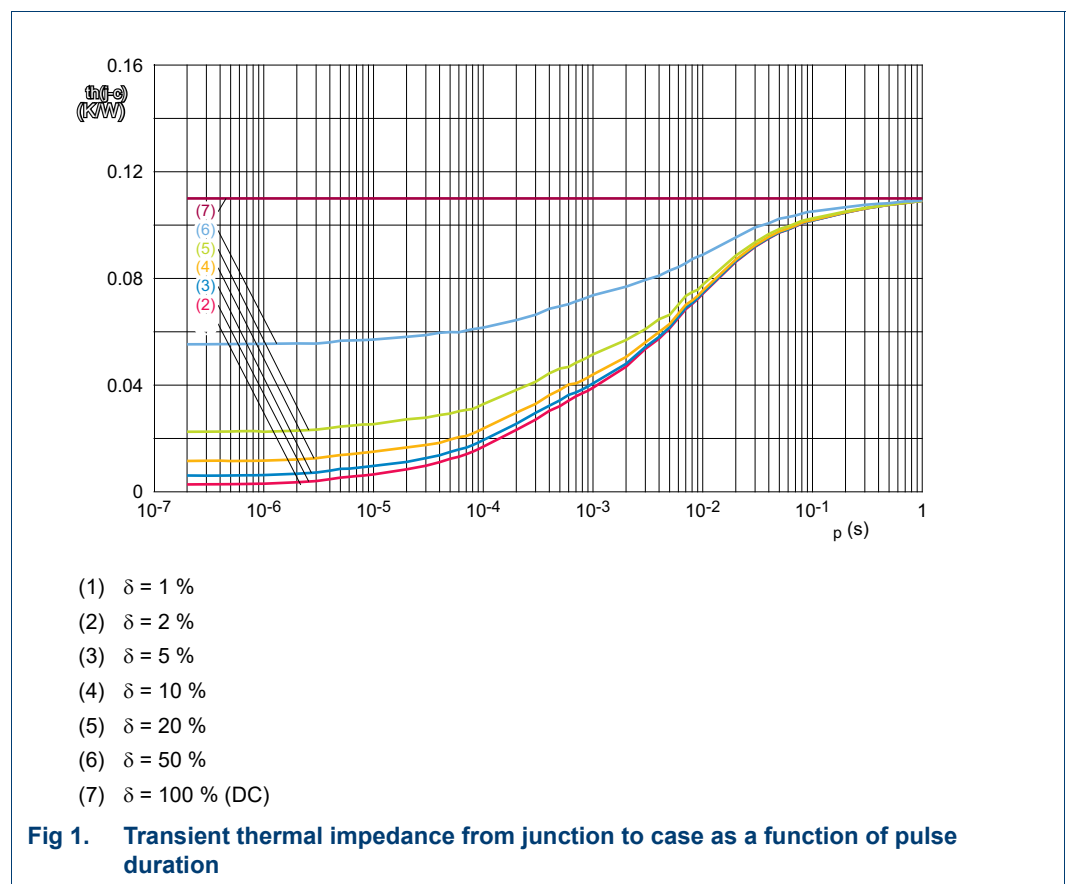
Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Typ	Unit
$R_{th(j-c)}$	thermal resistance from junction to case	$T_j = 150\text{ °C}$ [1][2]	0.11	K/W
$Z_{th(j-c)}$	transient thermal impedance from junction to case	$T_j = 150\text{ °C}$; $t_p = 100\text{ }\mu\text{s}$; $\delta = 20\text{ %}$	0.033	K/W

[1] T_j is the junction temperature.

[2] $R_{th(j-c)}$ is measured under RF conditions.

[3] See Figure 1.



6. Characteristics

Table 6. DC characteristics

$T_j = 25\text{ °C}$; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0\text{ V}$; $I_D = 6.6\text{ mA}$	135	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$V_{DS} = 10\text{ V}$; $I_D = 660\text{ mA}$	1.33	1.9	2.33	V
V_{GSq}	gate-source quiescent voltage	$V_{DS} = 50\text{ V}$; $I_D = 75\text{ mA}$	1.11	1.7	2.11	V
I_{DSS}	drain leakage current	$V_{GS} = 0\text{ V}$; $V_{DS} = 50\text{ V}$	-	-	2.8	μA

Table 6. DC characteristics ...continued
 $T_j = 25\text{ }^{\circ}\text{C}$; per section unless otherwise specified.

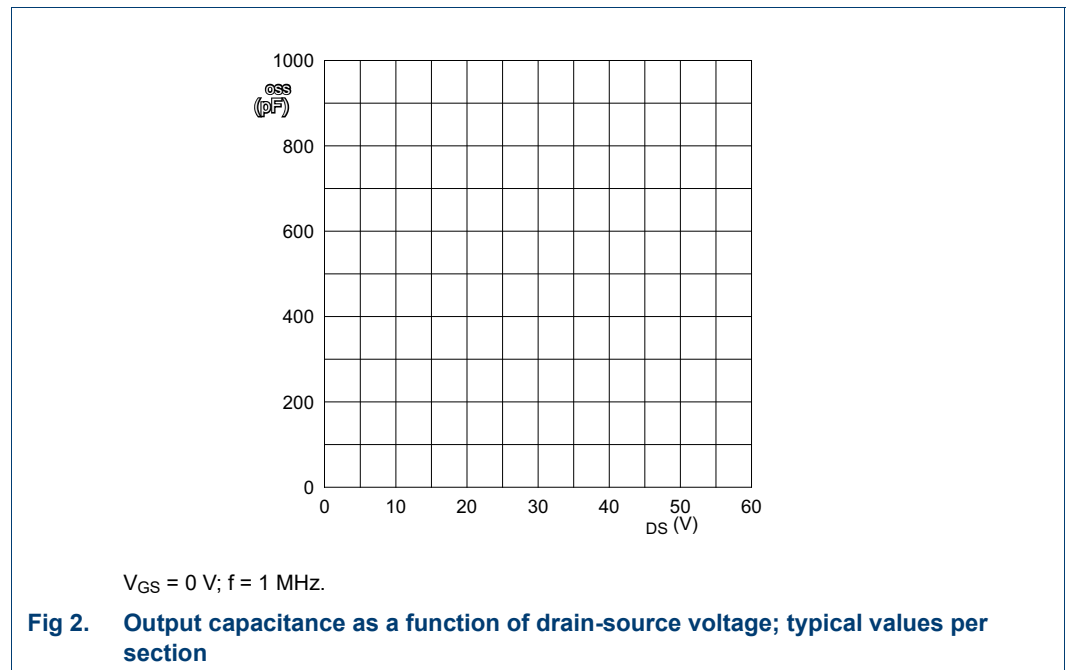
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75\text{ V}$; $V_{DS} = 10\text{ V}$	-	91	-	A
I_{GSS}	gate leakage current	$V_{GS} = 11\text{ V}$; $V_{DS} = 0\text{ V}$	-	-	280	nA
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75\text{ V}$; $I_D = 23.1\text{ A}$	-	0.066	-	Ω

Table 7. AC characteristics
 $T_j = 25\text{ }^{\circ}\text{C}$; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
C_{rs}	feedback capacitance	$V_{GS} = 0\text{ V}$; $V_{DS} = 50\text{ V}$; $f = 1\text{ MHz}$	-	4.9	-	pF
C_{iss}	input capacitance	$V_{GS} = 0\text{ V}$; $V_{DS} = 50\text{ V}$; $f = 1\text{ MHz}$	-	650	-	pF
C_{oss}	output capacitance	$V_{GS} = 0\text{ V}$; $V_{DS} = 50\text{ V}$; $f = 1\text{ MHz}$	-	247	-	pF

Table 8. RF characteristics
 Test signal: pulsed RF; $t_p = 100\text{ }\mu\text{s}$; $\delta = 20\%$; $f = 108\text{ MHz}$; RF performance at $V_{DS} = 50\text{ V}$;
 $I_{Dq} = 150\text{ mA}$; $T_{case} = 25\text{ }^{\circ}\text{C}$; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
G_p	power gain	$P_L = 1700\text{ W}$	24.5	26.2	-	dB
RL_{in}	input return loss	$P_L = 1700\text{ W}$	-	-14	-	dB
η_D	drain efficiency	$P_L = 1700\text{ W}$	71	74	-	%



7. Test information

7.1 Ruggedness in class-AB operation

The BLF189XRA and BLF189XRAS are capable of withstanding a load mismatch corresponding to VSWR > 65 : 1 through all phases under the following conditions: $V_{DS} = 50\text{ V}$; $I_{Dq} = 150\text{ mA}$; $P_L = 1700\text{ W}$ pulsed; $f = 108\text{ MHz}$.

7.2 Impedance information

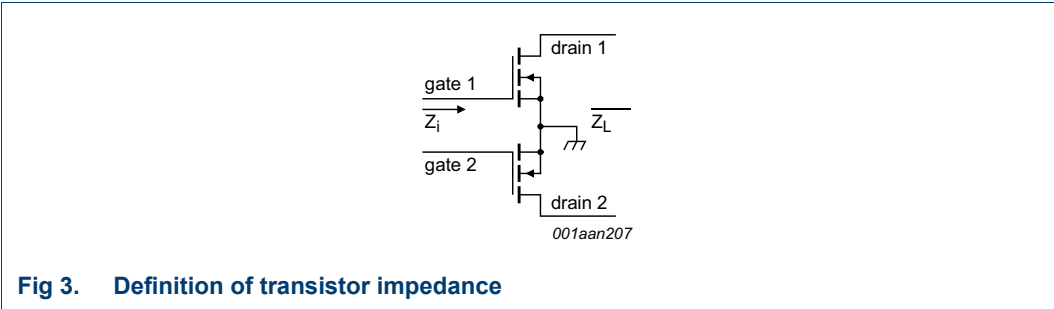


Table 9. Typical push-pull impedance
Simulated Z_i and Z_L device impedance; impedance info at $V_{DS} = 50\text{ V}$ and $P_L = 1700\text{ W}$.

f	Z_i	Z_L
(MHz)	(Ω)	(Ω)
108	$2.3 - j7.6$	$2.3 + j0.4$

7.3 Test circuit

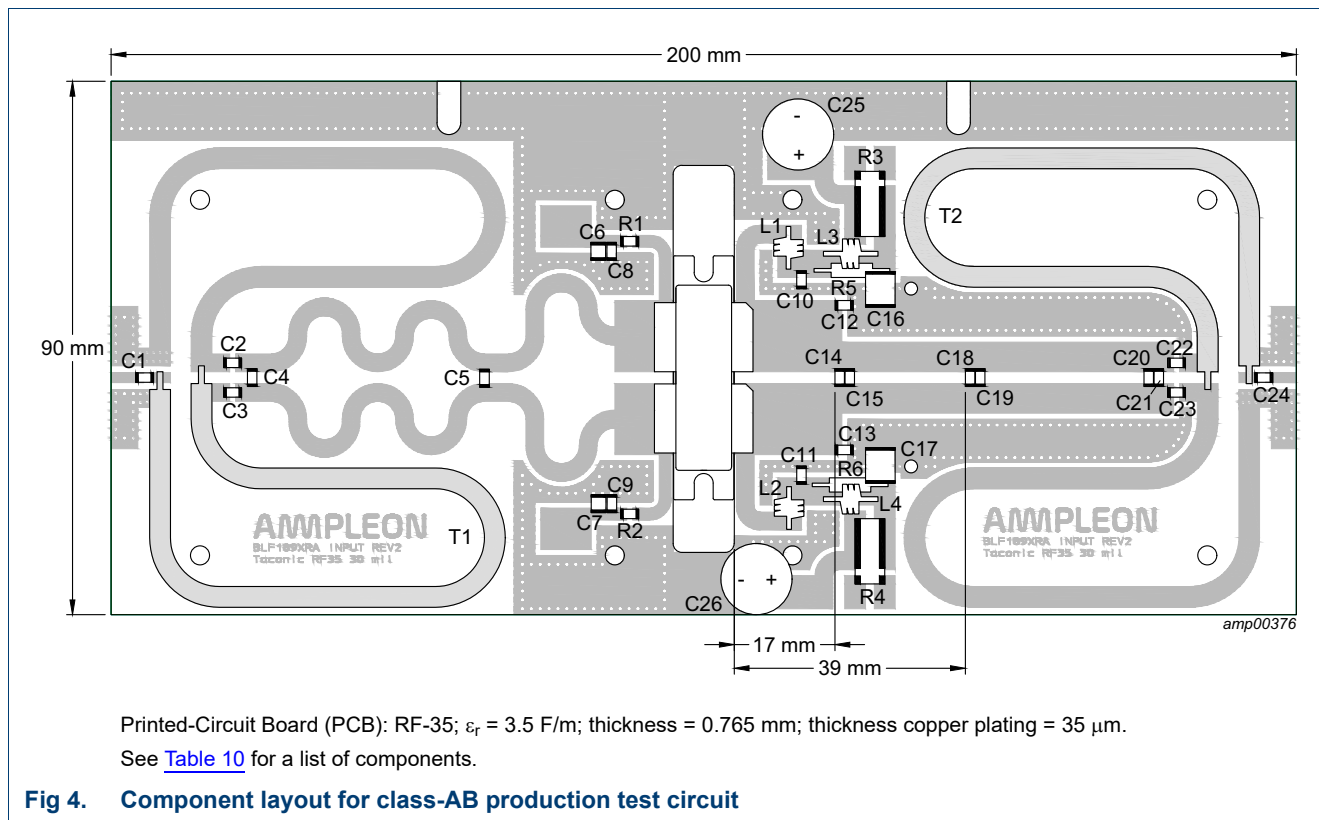


Table 10. List of components

For test circuit see [Figure 4](#).

Component	Description	Value	Remarks
C1	multilayer ceramic chip capacitor	470 pF	[1]
C2, C3	multilayer ceramic chip capacitor	68 pF	[1]
C4	multilayer ceramic chip capacitor	51 pF	[1]
C5	multilayer ceramic chip capacitor	300 pF	[1]
C6, C7	multilayer ceramic chip capacitor	4.7 μ F, 50 V	
C8, C9	multilayer ceramic chip capacitor	920 pF	[1]
C10, C11	multilayer ceramic chip capacitor	920 pF	[1]
C12, C13	multilayer ceramic chip capacitor	180 pF	[1]
C14, C15	multilayer ceramic chip capacitor	91 pF	[1]
C16, C17	multilayer ceramic chip capacitor	4.7 μ F, 100 V	
C18, C19	multilayer ceramic chip capacitor	56 pF	[1]
C20, C21	multilayer ceramic chip capacitor	51 pF	[1]
C22, C23	multilayer ceramic chip capacitor	100 pF	[1]
C24	multilayer ceramic chip capacitor	470 pF	[1]
C25, C26	electrolytic capacitor	2200 μ F, 64 V	
L1, L2	air inductor	3 turns, D = 4 mm, d = 1 mm	1 mm copper wire

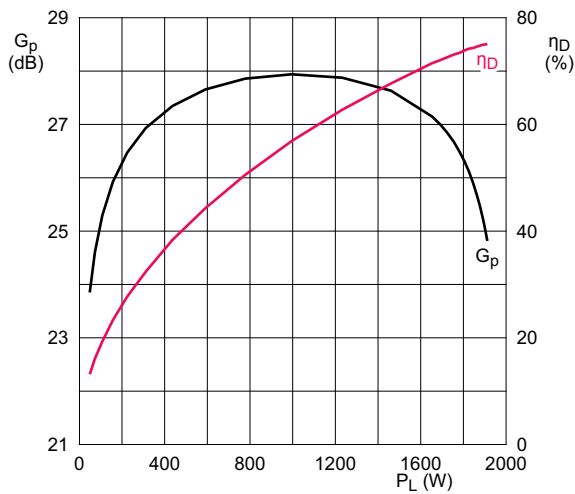
Table 10. List of components ...continued

For test circuit see [Figure 4](#).

Component	Description	Value	Remarks
L3, L4	air inductor	5 turns, D = 4 mm, d = 1 mm	1 mm copper wire
R1, R2	resistor	4.7 k Ω	SMD 1206
R3, R4	resistor	0.01 Ω	FC4L110R010FER
R5, R6	resistor	4.7 Ω , 0.6 W	SMD 1206
T1, T2	semi rigid coax	50 Ω , 160 mm	EZ141-AL-TP/M17

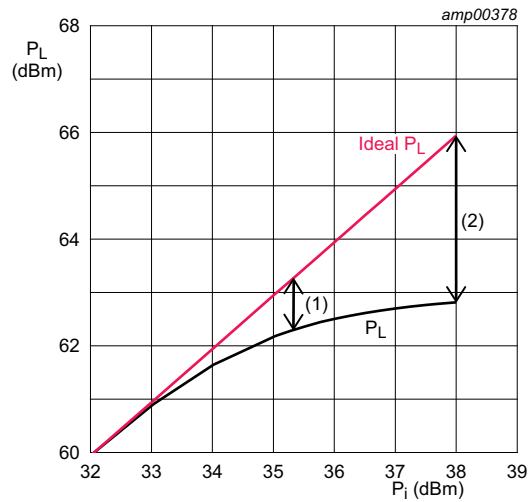
[1] American Technical Ceramics type 100B or capacitor of same quality

7.4 Graphical data



$V_{DS} = 50$ V; $I_{DQ} = 150$ mA; $f = 108$ MHz; $t_p = 100$ μ s;
 $\delta = 20$ %.

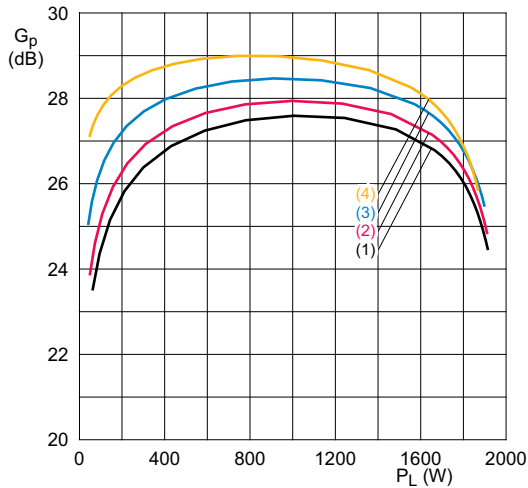
Fig 5. Power gain and drain efficiency as function of output power; typical values



$V_{DS} = 50$ V; $I_{DQ} = 150$ mA; $f = 108$ MHz; $t_p = 100$ μ s;
 $\delta = 20$ %.

- (1) $P_{L(1dB)} = 62.3$ dBm (1704 W)
- (2) $P_{L(3dB)} = 62.8$ dBm (1906 W)

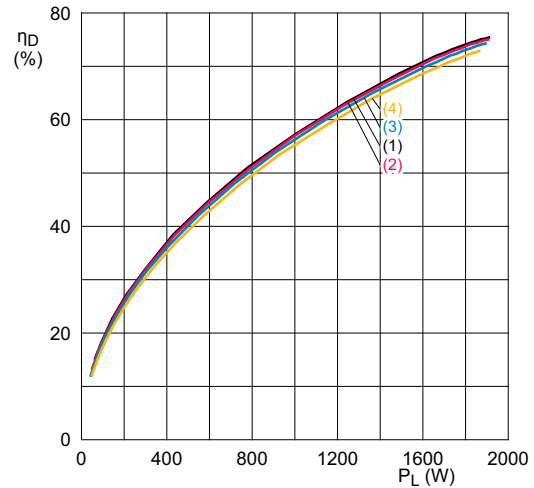
Fig 6. Output power as a function of input power; typical values



$V_{DS} = 50 \text{ V}$; $f = 108 \text{ MHz}$; $t_p = 100 \text{ } \mu\text{s}$; $\delta = 20 \text{ } \%$.

- (1) $I_{Dq} = 50 \text{ mA}$
- (2) $I_{Dq} = 150 \text{ mA}$
- (3) $I_{Dq} = 600 \text{ mA}$
- (4) $I_{Dq} = 2000 \text{ mA}$

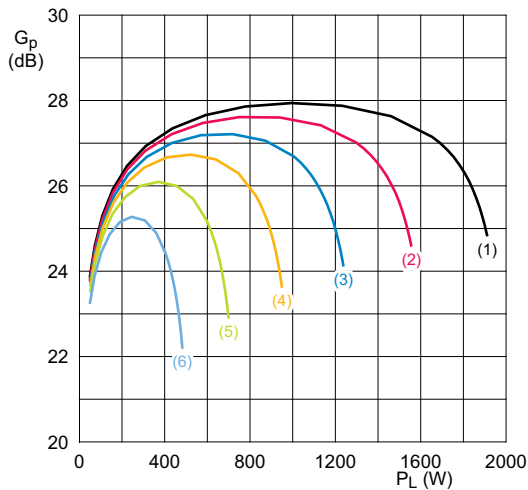
Fig 7. Power gain as a function of output power; typical values



$V_{DS} = 50 \text{ V}$; $f = 108 \text{ MHz}$; $t_p = 100 \text{ } \mu\text{s}$; $\delta = 20 \text{ } \%$.

- (1) $I_{Dq} = 50 \text{ mA}$
- (2) $I_{Dq} = 150 \text{ mA}$
- (3) $I_{Dq} = 600 \text{ mA}$
- (4) $I_{Dq} = 2000 \text{ mA}$

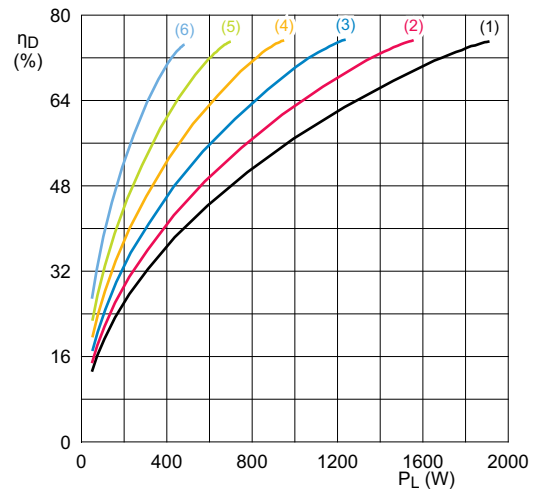
Fig 8. Drain efficiency as a function of output power; typical values



$I_{Dq} = 150 \text{ mA}$; $f = 108 \text{ MHz}$; $t_p = 100 \text{ } \mu\text{s}$; $\delta = 20 \text{ } \%$.

- (1) $V_{DS} = 50 \text{ V}$
- (2) $V_{DS} = 45 \text{ V}$
- (3) $V_{DS} = 40 \text{ V}$
- (4) $V_{DS} = 35 \text{ V}$
- (5) $V_{DS} = 30 \text{ V}$
- (6) $V_{DS} = 25 \text{ V}$

Fig 9. Power gain as a function of output power; typical values



$I_{Dq} = 150 \text{ mA}$; $f = 108 \text{ MHz}$; $t_p = 100 \text{ } \mu\text{s}$; $\delta = 20 \text{ } \%$.

- (1) $V_{DS} = 50 \text{ V}$
- (2) $V_{DS} = 45 \text{ V}$
- (3) $V_{DS} = 40 \text{ V}$
- (4) $V_{DS} = 35 \text{ V}$
- (5) $V_{DS} = 30 \text{ V}$
- (6) $V_{DS} = 25 \text{ V}$

Fig 10. Drain efficiency as a function of output power; typical values

8. Package outline

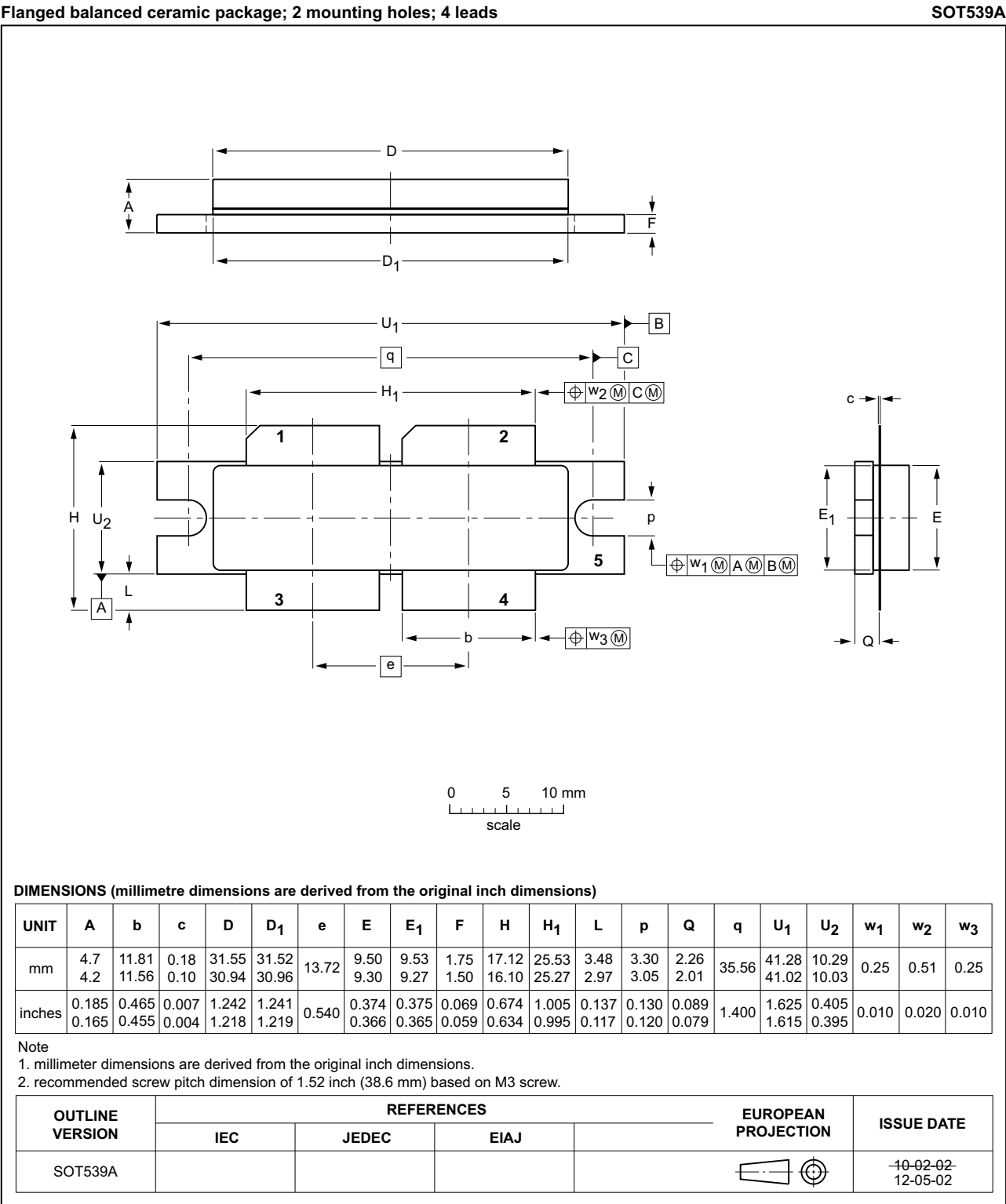
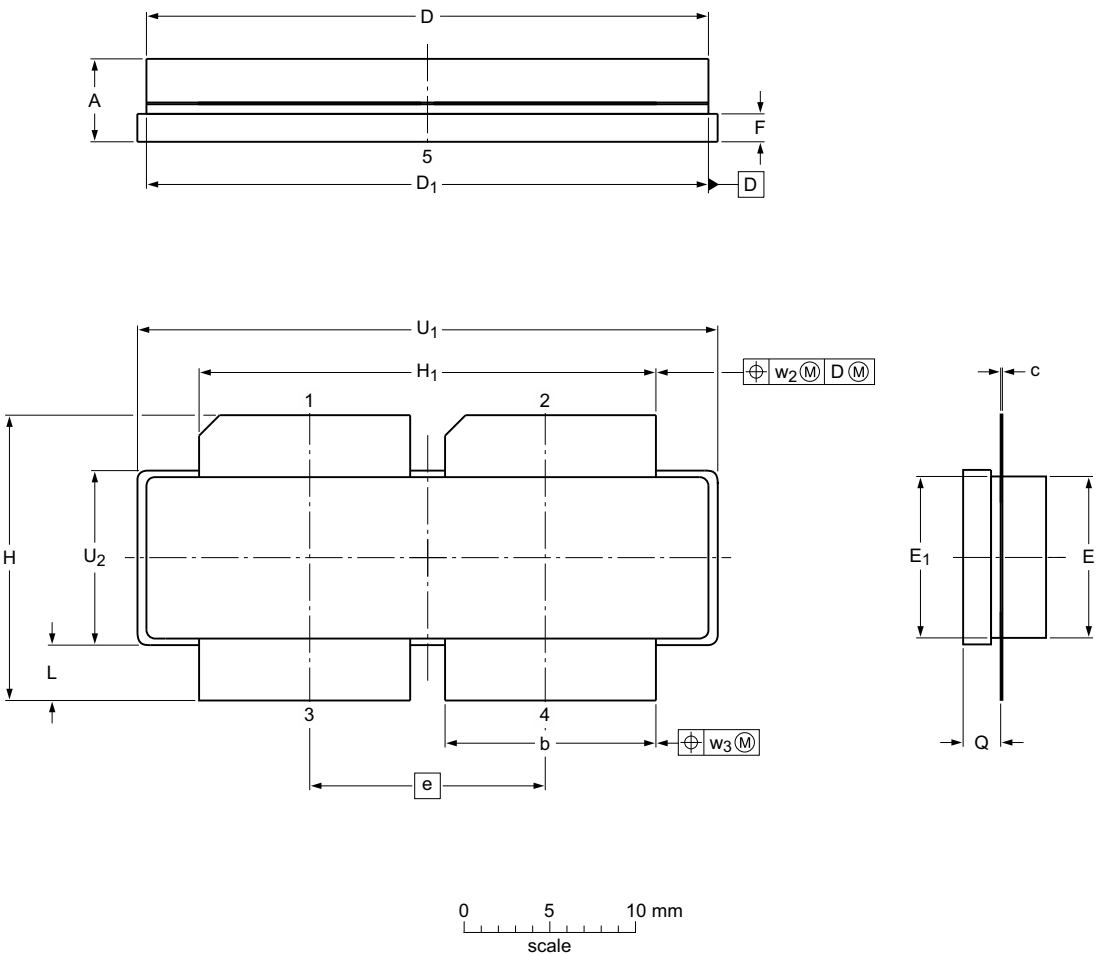


Fig 11. Package outline SOT539A

Earless flanged balanced ceramic package; 4 leads

SOT539B



Dimensions

Unit ⁽¹⁾	A	b	c	D	D ₁	E	E ₁	e	F	H	H ₁	L	Q	U ₁	U ₂	w ₂	w ₃
mm	max	4.7	11.81	0.18	31.55	31.52	9.5	9.53		1.75	17.12	25.53	3.48	2.26	32.39	10.29	
	nom							13.72								0.25	0.25
	min	4.2	11.56	0.10	30.94	30.96	9.3	9.27		1.50	16.10	25.27	2.97	2.01	32.13	10.03	
inches	max	0.185	0.465	0.007	1.242	1.241	0.374	0.375		0.069	0.674	1.005	0.137	0.089	1.275	0.405	
	nom							0.54								0.01	0.01
	min	0.165	0.455	0.004	1.218	1.219	0.366	0.365		0.059	0.634	0.995	0.117	0.079	1.265	0.395	

Note

1. millimeter dimensions are derived from the original inch dimensions.

sot539b_po

Outline version	References			European projection	Issue date
	IEC	JEDEC	JEITA		
SOT539B					12-05-02 13-05-24

Fig 12. Package outline SOT539B

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

Table 11. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	C2A [1]
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	2 [2]

[1] CDM classification C2A is granted to any part that passes after exposure to an ESD pulse of 500 V, but fails after exposure to an ESD pulse of 750 V.

[2] HBM classification 2 is granted to any part that passes after exposure to an ESD pulse of 2000 V, but fails after exposure to an ESD pulse of 4000 V.

10. Abbreviations

Table 12. Abbreviations

Acronym	Description
CW	Continuous Wave
ESD	ElectroStatic Discharge
HF	High Frequency
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MTF	Median Time to Failure
SMD	Surface Mounted Device
VSWR	Voltage Standing Wave Ratio

11. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF189XRA_BLF189XRAS v.1	20171106	Product data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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For sales office addresses, please visit: <http://www.ampleon.com/sales>

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